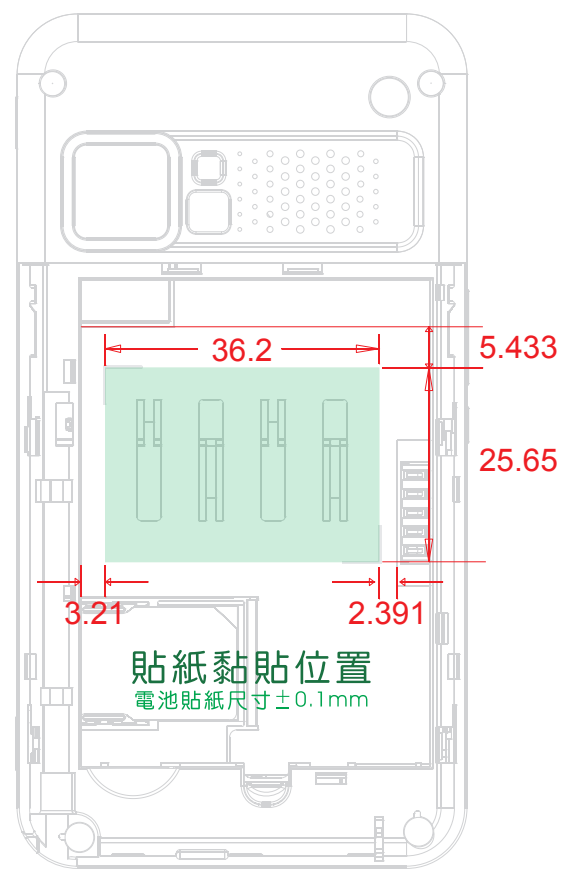
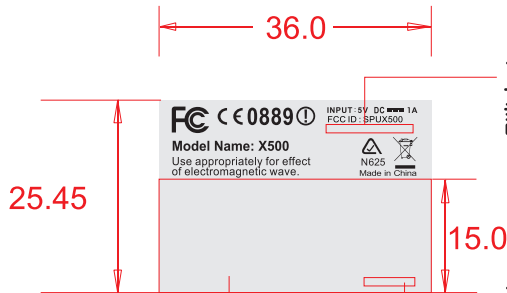


工廠加印P/N, IMEI及S/N
軟硬體版次後樣式



貼紙黏貼位置
電池貼紙尺寸±0.1mm



工廠於此區域依
語文別加印P/N

工廠於此區域
加印軟體版次

於此區域(36x15mm)
加印IMEI及S/N 條碼使
用CODE 128

H/S and PCB:

	Model/Project	Year	Month	Line	Series Number	
	PCB/Handset	H/W	Date			
	X	XXX	XXX	X	X	X XXXX
H/S(Model):	H	000	000	0	0	0 0000
PCB(Project):	P	000	000	0	0	0 0000

0320190

<<右下角代碼>> 為"軟體版本代碼"
如目前已發行的軟體為
ETEN_X500_CHT_A30_032_0190_FCD11AFC.NB0
編碼取自軟體名稱以0320190示意

PCB/Handset:

PCB: QCI: P, TYC: A, PAC(Brazil): Z

Handset: QCI: H, TYC: B, PAC(Brazil): Z, POP(SF): S

Model/Project:

Model: By customer define (R81, R82, K72), and following the Project => Handset uses

Project: By PM define (YT1) for unique platform. = > PCBA uses

** We need PM to provide the reference table between project code and model name.

H/W: Hardware version(included PCB version and ECR version), which will be controlled by project PE owner.

Year: What year: 0~9 (ex: 0= 2000, 1= 2001.....).

Month: What month: 1,2....8,9,A,B,C (ex: 1= Jan,..., 9=Sep, A= Oct, B= Nov, C=Dec).

Date: What date: 1~9, A~X.(except character letter I and O)

Line: What line produce (ex: A,B or C...).

Series Number: as title (total 4 bytes, each byte display from 0~9,A~Z).(except character letter I and O)